

RF360 Europe GmbH

A Qualcomm – TDK Joint Venture

SAW components

SAW RF filter

Automotive telematics

Series/type: B4353 Ordering code: B39162B4353P810

Date: Version: June 01, 2016 2.0

RF360 products mentioned within this document are offered by RF360 Europe GmbH and other subsidiaries of RF360 Holdings Singapore Pte. Ltd. (collectively, the "RF360 Subsidiaries"). RF360 Holdings Singapore Pte. Ltd. is a joint venture of Qualcomm Global Trading Pte. Ltd. and EPCOS AG. References in this documentation to EPCOS AG should properly reference, and shall be read to reference, the RF360 Subsidiaries.

RF360 Europe GmbH, Anzinger Str. 13, München, Germany

© 2016 RF360 Europe GmbH and/or its affiliated companies. All rights reserved.

These materials, including the information contained herein, may be used only for informational purposes by the customer. The RF360 Subsidiaries assume no responsibility for errors or omissions in these materials or the information contained herein. The RF360 Subsidiaries reserve the right to make changes to the product(s) or information contained herein without notice. The materials and information are provided on an AS IS basis, and the RF360 Subsidiaries assume no liability and make no warranty or representation, either expressed or implied, with respect to the materials, or any output or results based on the use, application, or evaluation of such materials, including, without limitation, with respect to the non-infringement of trademarks, patents, copyrights or any other intellectual property rights or other rights of third parties.

No use of this documentation or any information contained herein grants any license, whether express, implied, by estoppel or otherwise, to any intellectual property rights, including, without limitation, to any patents owned by QUALCOMM Incorporated or any of its subsidiaries.

Not to be used, copied, reproduced, or modified in whole or in part, nor its contents revealed in any manner to others without the express written permission of RF360 Europe GmbH.

Qualcomm and Qualcomm RF360 are trademarks of Qualcomm Incorporated, registered in the United States and other countries. RF360 is a trademark of Qualcomm Incorporated. Other product and brand names may be trademarks or registered trademarks of their respective owners.

This technical data may be subject to U.S. and international export, re-export, or transfer ("export") laws. Diversion contrary to U.S. and international law is strictly prohibited.



SAW RF filter Automotive telematics

Series/type:	B4353
Ordering code:	B39162B4353P810
Date:	June 01, 2016
Version:	2.0

© EPCOS AG 2016. Reproduction, publication and dissemination of this data sheet, enclosures hereto and the information contained therein without EPCOS' prior express consent is prohibited.

EPCOS AG is a TDK Group Company.



B4353

1582.4 MHz

SAW components

SAW RF filter

Data sheet

Table of contents

olication
<u>atures</u>
<u></u>
configuration
tching circuit
aracteristics
ximum ratings
nsmission coefficient
flection coefficients
acking material
arking12
oldering profile
SD protection of SAW filters
<u>notations</u>
autions and warnings
ortant notes
Didering profile



SAW RF filter

Data sheet

1 Application

- Low-loss RF GPS, COMPASS, Galileo, GLONASS filter
- Simultaneous usages of GPS, COMPASS, Galileo and GLONASS
- Usable pass band: 2.0 MHz for GPS, 4.092 MHz for COMPASS, 4.092 MHz for Galileo and 7.88 MHz for GLONASS
- Very low insertion attenuation
- High out of band selectivity
- Low amplitude ripple
- No matching network required for operation at 50 Ω

2 Features

- Package size 1.4±0.1 mm × 1.1±0.1 mm
- Package height 0.45 mm (max.)
- Package code QCS5P
- Approximate weight 3 mg
- RoHS compatible
- Package for Surface Mount Technology (SMT)
- Ni/Au-plated terminals
- Filter surface passivated
- AEC-Q200 qualified component family
- Electrostatic Sensitive Device (ESD)



Figure 1: Picture of component with example of product marking.

B4353



B4353

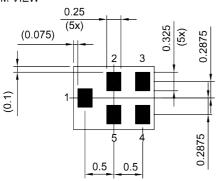
SAW components

SAW RF filter

Data sheet

3 Package

BOTTOM VIEW



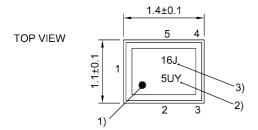
Pad and pitch tolerance ±0.05

4 Pin configuration

- ∎ 1 Input
- 4 Output
- 2, 3, 5 Ground

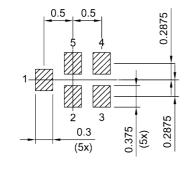
SIDE VIEW

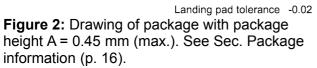




- 1) Marking for pad number 1
- 2) Example of encoded lot number
- 3) Example of encoded filter type number









B4353

SAW components

SAW RF filter

Data sheet

5 Matching circuit

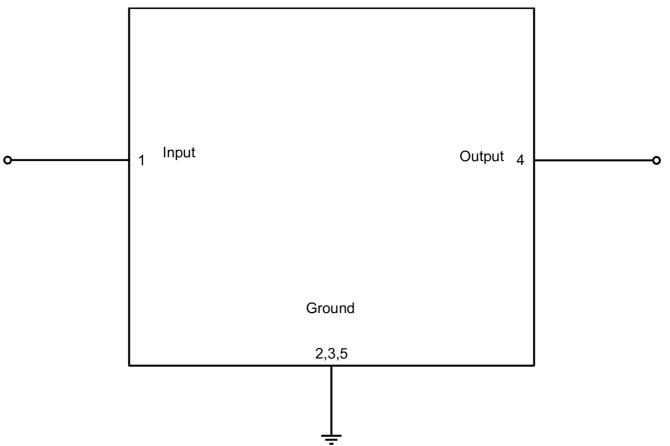


Figure 3: Schematic of matching circuit. No external matching components required.



SAW RF filter

Data sheet

6 Characteristics

Temperature range for specification	T _{SPEC}	= −40 °C +125 °C
Input terminating impedance	Z _{IN}	= 50 Ω
Output terminating impedance	Z _{OUT}	= 50 Ω

Characteristics				min. for $T_{_{\rm SPEC}}$	typ. @+25 °C	max. for $T_{_{\rm SPEC}}$	
Center frequency			f _c	_	1582.4	—	MHz
Maximum insertion attenuation			$\alpha_{_{max}}$				
	1559.05 1563.15	MHz		_	1.3	2.0	dB
	1573.37 1577.47	MHz		_	1.0	2.0	dB
	1574.42 1576.42	MHz		_	1.0	1.4	dB
	1597.78 1605.66	MHz			1.5	2.2	dB
Variation of group delay			$\Delta au_{ m var}$				
	1597.78 1605.66	MHz		—	4.0	14	ns ¹⁾
Maximum VSWR			VSWR _{max}				
@ input port	1559.05 1563.15	MHz		_	1.6	2.1	
	1573.37 1577.47	MHz		_	1.3	2.1	
	1574.42 1576.42	MHz		_	1.3	2.1	
	1597.78 1605.66	MHz		—	1.6	2.1	
@ output port	1559.05 1563.15	MHz		_	1.7	2.1	
	1573.37 1577.47	MHz		—	1.4	2.1	
	1574.42 1576.42	MHz		_	1.3	2.1	
	1597.78 1605.66	MHz		_	1.5	2.1	
Minimum attenuation			$\alpha_{_{min}}$				
	50 824	MHz		40	43		dB
	824 925	MHz		39	43	—	dB
	1427 1453	MHz		43	48	—	dB
	1710 1785	MHz		32	42	—	dB
	1850 1910	MHz		38	45	—	dB
	1920 1980	MHz		39	46	—	dB
	2400 2500	MHz		43	47	—	dB
	2500 2570	MHz		38	46	—	dB
	2600 3000	MHz		34	41	_	dB

¹⁾ Averaged over 2 MHz.

B4353



SAW RF filter

Data sheet

7 Maximum ratings

Operable temperature	<i>T</i> _{OP} = −40 °C +125 °C	
Storage temperature	<i>T</i> _{stg} = -40 °C +125 °C	
DC voltage	$V_{\rm DC} = 0 V$	
Input power	P _{IN}	
@ input port: 915 MHz	23 dBm	Continuous wave for 5000 h @ 50 °C.
@ input port: 1453 MHz	15 dBm	Continuous wave for 100000 h @ 55 °C.
@ input port: 1710 MHz	15 dBm	Continuous wave for 100000 h @ 55 °C.

B4353



B4353

SAW components

SAW RF filter

Data sheet

0.0

1.0

2.0

3.0

4.0

5.0

0.0

20.0

40.0

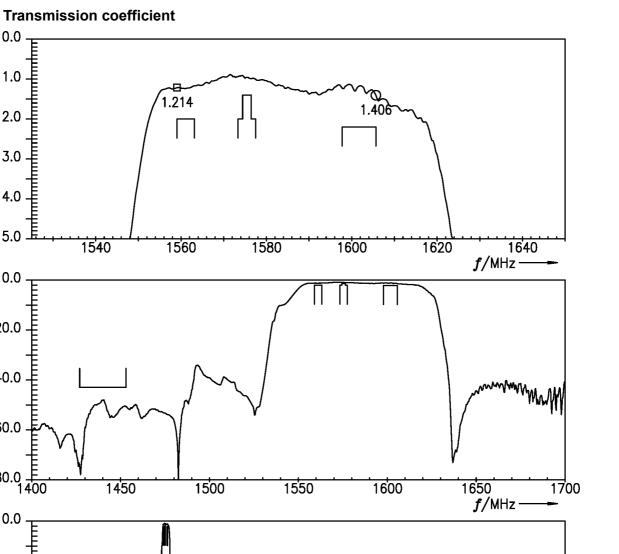
60.0

80.0 1

— α/dB

8

- a/dB



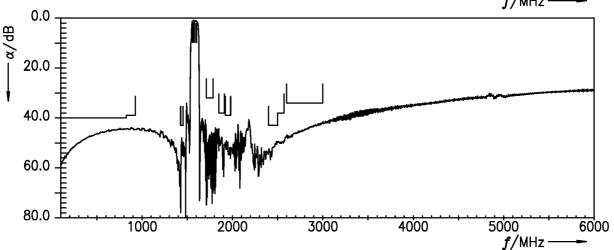


Figure 4: Attenuation.



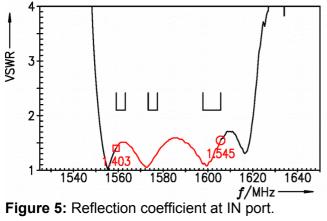
B4353

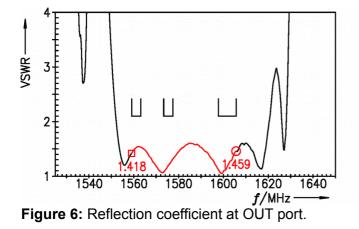
SAW components

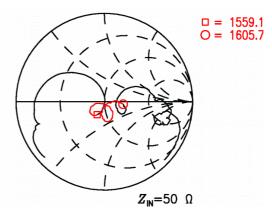
SAW RF filter

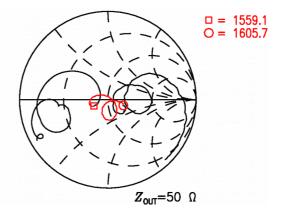
Data sheet

9 **Reflection coefficients**











B4353

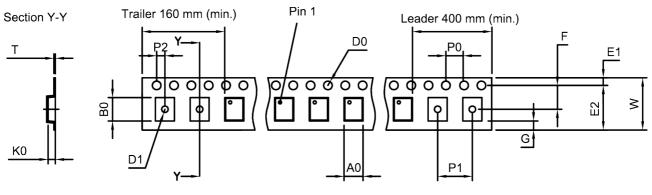
SAW components

SAW RF filter

Data sheet

10 Packing material

10.1 Tape



User direction of unreeling

Figure 7: Drawing of tape (first-angle projection) with tape dimensions according to Table 1.

A ₀	1.27±0.05 mm
B₀	1.57±0.05 mm
D ₀	1.5+0.1/-0 mm
D ₁	0.5±0.1 mm
E₁	1.75±0.1 mm

E2	6.25 mm (min.)
F	3.5±0.05 mm
G	0.75 mm (min.)
K ₀	0.62±0.05 mm
P ₀	4.0±0.1 mm

P ₁	4.0±0.1 mm
P ₂	2.0±0.05 mm
Т	0.25±0.03 mm
W	8.0+0.3/-0.1 mm

 Table 1: Tape dimensions.

10.2 Reel with diameter of 180 mm

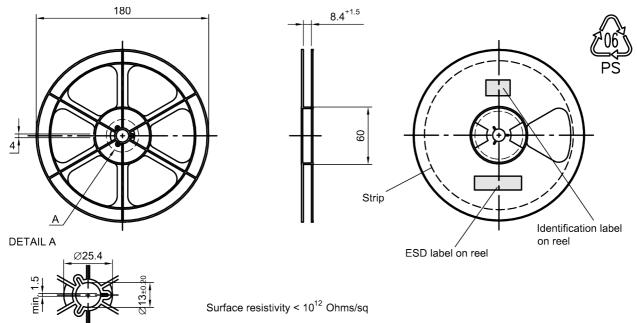
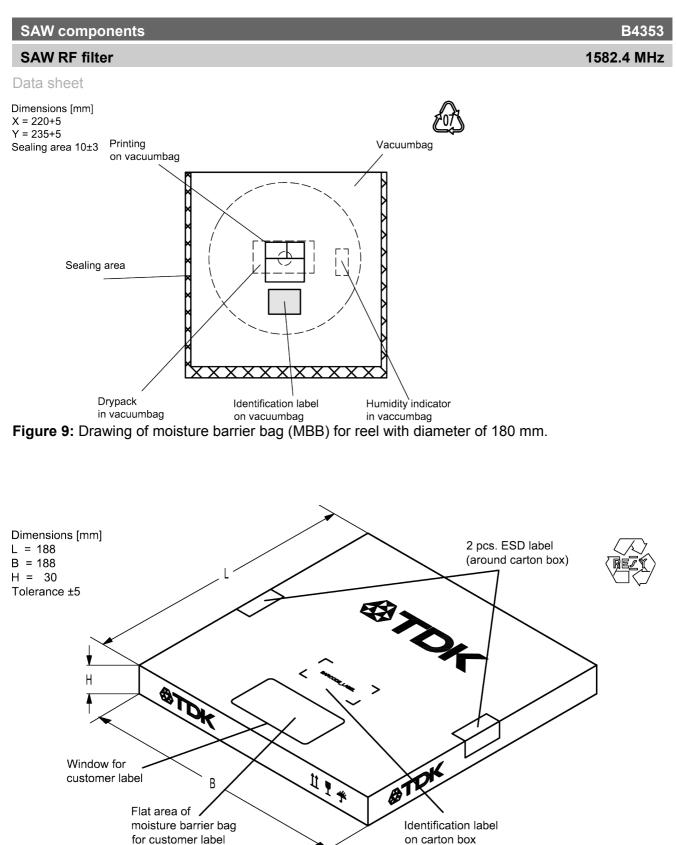
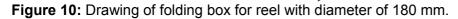


Figure 8: Drawing of reel (first-angle projection) with diameter of 180 mm.









SAW con	nponents							B4353
SAW RF filter 15						1582.4 MHz		
Data sheet								
11 Markir	าต							
	•	with produc	t type num	her and	lot number	encoded a	ccording to	Table 2:
		with produc	i type num			encoueu a	ccoruing to	
Type nur	nber:							
		nber of the ecial BASE3			jit marking.	e.g., E	33xxxxB <u>123</u>	3 <u>4</u> xxxx,
Example	of decodin	g type num	ber marking	g on de	vice		in decimal	code.
-	16J			-	=>		123	34
The BAS		2 ² + 6 x 32 ¹ for product	• • •		=		123	34
■ Lot num	oer:							
		he lot numb on a specia		code in	to a 3 digit r	e.g., narking.	123	345 ,
		•			0		in decimal	code
Example of decoding lot number marking on device 5UY =>						123		
5 x 47 ² + 27 (=U) x 47 ¹ + 31 (=				(=Y) ×	47 [°] =		123	-
Adopte	d BASE32 co	ode for type i	number		Adopted BASE47 code for lot number			
Decimal	Base32	Decimal	Base32	-	Decimal	Base47	Decimal	Base47
value	code	value	code	_	value	code	value	code
0	0	16	G	_	0	0	24	R
1	1	17	Н	_	1	1	25	S
2	2	18	J	_	2	2	26	Т
3	3	19	K	_	3	3	27	U
4	4	20	M	_	4	4	28	V
5	5	21	N	_	5	5	29	W
6	6	22	Р	-	6	6	30	X
7	7	23	Q	_	7	7	31	Y
8	8	24	R	-	8	8	32	Z
9	9	25	S	-	9	9	33	b
10	A	26	Т	-	10	A	34	d

Table 2: Lists for encoding and decoding of marking.

27

28

29

30

31

V

W

Х

Y

Ζ

В

С

D

Е

F

11

12

13

14

15

11

12

13

14

15

16

17

18

19

20

21

22

23

В

С

D

Е

F

G

Н

J

Κ

L

Μ

Ν

Ρ

35

36

37

38

39

40

41

42

43

44

45

46

f

h

n

r

t

v

١

?

{

}

<

>



SAW RF filter

Data sheet

12 Soldering profile

The recommended soldering process is in accordance with IEC 60068-2-58 – 3rd edit and IPC/JEDEC J-STD-020B.

ramp rate	≤ 3 K/s		
preheat	125 °C to 220 °C, 150 s to 210 s, 0.4 K/s to 1.0 K/s		
<i>T</i> > 220 °C	30 s to 70 s		
<i>T</i> > 230 °C	min. 10 s		
<i>T</i> > 245 °C	max. 20 s		
<i>T</i> ≥ 255 °C	-		
peak temperature T_{peak}	250 °C +0/-5 °C		
wetting temperature T_{min}	230 °C +5/-0 °C for 10 s ± 1 s		
cooling rate	≤ 3 K/s		
soldering temperature T	oldering temperature T measured at solder pads		
	l.		

Table 3: Characteristics of recommended soldering profile for lead-free solder (Sn95.5Ag3.8Cu0.7).

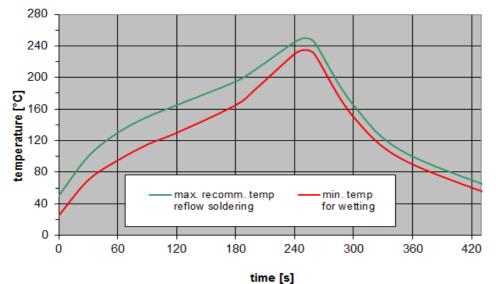


Figure 11: Recommended reflow profile for convection and infrared soldering – lead-free solder.

B4353



SAW RF filter

Data sheet

13 ESD protection of SAW filters

SAW filters are Electro Static Discharge sensitive devices. To reduce the probability of damages caused by ESD, special matching topologies have to be applied.

In general, "ESD matching" has to be ensured at that filter port, where electrostatic discharge is expected.

Electrostatic discharges predominantly appear at the antenna input of RF receivers. Therefore, only the input matching of the SAW filter has to be designed to short circuit or to block the ESD pulse.

Below three figures show recommended "ESD matching" topologies.

For wide band filters the high-pass ESD matching structure needs to be at least of 3rd order to ensure a proper matching for any impedance value of antenna and SAW filter input. The required component values have to be determined from case to case.

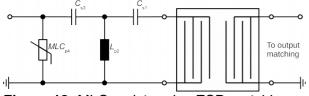


Figure 12: MLC varistor plus ESD matching.

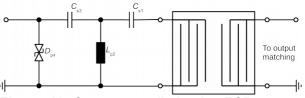


Figure 13: Suppressor diode plus ESD matching.

In cases where minor ESD occur, following simplified "ESD matching" topologies can be used alternatively.

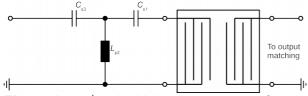


Figure 14: 3rd order high-pass structure for basic ESD protection.

In all three figures the shunt inductor L_{p2} could be replaced by a shorted microstrip with proper length and width. If this configuration is possible depends on the operating frequency and available PCB space.

Effectiveness of the applied ESD protection has to be checked according to relevant industry standards or customer specific requirements.

For further information, please refer to EPCOS Application report: **"ESD protection for SAW filters"**. This report can be found under <u>www.epcos.com/rke</u>. Click on "Applications Notes".

B4353



SAW RF filter

Data sheet

14 Annotations

14.1 Matching coils

See TDK inductor pdf-catalog <u>http://www.tdk.co.jp/tefe02/coil.htm#aname1</u> and Data Library for circuit simulation <u>http://www.tdk.co.jp/etvcl/index.htm</u>.

14.2 RoHS compatibility

ROHS-compatible means that products are compatible with the requirements according to Art. 4 (substance restrictions) of Directive 2011/65/EU of the European Parliament and of the Council of June 8th, 2011, on the restriction of the use of certain hazardous substances in electrical and electronic equipment ("Directive") with due regard to the application of exemptions as per Annex III of the Directive in certain cases.

14.3 Scattering parameters (S-parameters)

The pin/port assignment is available in the headers of the S-parameter files. Please contact your local EPCOS sales office.

B4353



SAW RF filter

Data sheet

15 Cautions and warnings

15.1 Display of ordering codes for EPCOS products

The ordering code for one and the same product can be represented differently in data sheets, data books, other publications and the website of EPCOS, or in order-related documents such as shipping notes, order confirmations and product labels. The varying representations of the ordering codes are due to different processes employed and do not affect the specifications of the respective products. Detailed information can be found on the Internet under <u>www.epcos.com/orderingcodes</u>.

15.2 Material information

Due to technical requirements components may contain dangerous substances. For information on the type in question please also contact one of our sales offices.

15.3 Moldability

Before using in overmolding environment, please contact your local EPCOS sales office.

15.4 Package information

Landing area

The printed circuit board (PCB) land pattern (landing area) shown is based on EPCOS internal development and empirical data and illustrated for example purposes, only. As customers' SMD assembly processes may have a plenty of variants and influence factors which are not under control or knowledge of EPCOS, additional careful process development on customer side is necessary and strongly recommended in order to achieve best soldering results tailored to the particular customer needs.

Dimensions

Unless otherwise specified all dimensions are understood using unit millimeter (mm).

Dimensions do not include burrs.

Projection method

Unless otherwise specified first-angle projection is applied.

B4353



Important notes

The following applies to all products named in this publication:

- 1. Some parts of this publication contain statements about the suitability of our products for certain areas of application. These statements are based on our knowledge of typical requirements that are often placed on our products in the areas of application concerned. We nevertheless expressly point out that such statements cannot be regarded as binding statements about the suitability of our products for a particular customer application. As a rule, EPCOS is either unfamiliar with individual customer applications or less familiar with them than the customers themselves. For these reasons, it is always ultimately incumbent on the customer to check and decide whether an EPCOS product with the properties described in the product specification is suitable for use in a particular customer application.
- 2. We also point out that in individual cases, a malfunction of electronic components or failure before the end of their usual service life cannot be completely ruled out in the current state of the art, even if they are operated as specified. In customer applications requiring a very high level of operational safety and especially in customer applications in which the malfunction or failure of an electronic component could endanger human life or health (e.g. in accident prevention or life-saving systems), it must therefore be ensured by means of suitable design of the customer application or other action taken by the customer (e.g. installation of protective circuitry or redundancy) that no injury or damage is sustained by third parties in the event of malfunction or failure of an electronic component.
- 3. The warnings, cautions and product-specific notes must be observed.
- 4. In order to satisfy certain technical requirements, some of the products described in this publication may contain substances subject to restrictions in certain jurisdictions (e.g. because they are classed as hazardous). Useful information on this will be found in our Material Data Sheets on the Internet (<u>www.epcos.com/material</u>). Should you have any more detailed questions, please contact our sales offices.
- 5. We constantly strive to improve our products. Consequently, the products described in this publication may change from time to time. The same is true of the corresponding product specifications. Please check therefore to what extent product descriptions and specifications contained in this publication are still applicable before or when you place an order. We also reserve the right to discontinue production and delivery of products. Consequently, we cannot guarantee that all products named in this publication will always be available.

The aforementioned does not apply in the case of individual agreements deviating from the foregoing for customer-specific products.

- 6. Unless otherwise agreed in individual contracts, all orders are subject to the current version of the "General Terms of Delivery for Products and Services in the Electrical Industry" published by the German Electrical and Electronics Industry Association (ZVEI).
- 7. The trade names EPCOS, Alu-X, CeraDiode, CeraLink, CeraPad, CeraPlas, CSMP, CSSP, CTVS, DeltaCap, DigiSiMic, DSSP, ExoCore, FilterCap, FormFit, LeaXield, MiniBlue, MiniCell, MKD, MKK, MotorCap, PCC, PhaseCap, PhaseCube, PhaseMod, PhiCap, PQSine, SIFERRIT, SIFI, SIKOREL, SilverCap, SIMDAD, SiMic, SIMID, SineFormer, SIOV, SIP5D, SIP5K, TFAP, ThermoFuse, WindCap are trademarks registered or pending in Europe and in other countries. Further information will be found on the Internet at www.epcos.com/trademarks.